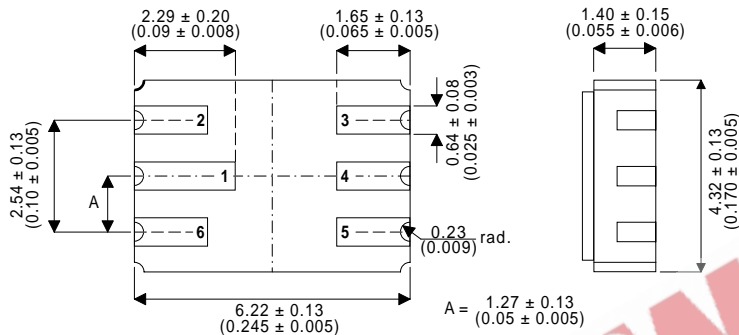


HIGH VOLTAGE, MEDIUM POWER, NPN DUAL TRANSISTOR IN A HERMETICALLY SEALED CERAMIC SURFACE MOUNT PACKAGE FOR HIGH RELIABILITY APPLICATIONS

MECHANICAL DATA
Dimensions in mm (inches)



LCC2 PACKAGE
Underside View

- | | |
|---------------------|---------------------|
| PAD 1 – Collector 1 | PAD 4 – Collector 2 |
| PAD 2 – Base 1 | PAD 5 – Emitter 2 |
| PAD 3 – Base 2 | PAD 6 – Emitter 1 |

FEATURES

- DUAL SILICON PLANAR EPITAXIAL NPN TRANSISTOR
- HERMETIC CERAMIC SURFACE MOUNT PACKAGE
- CECC SCREENING OPTIONS
- SPACE QUALITY LEVELS OPTIONS
- HIGH VOLTAGE

APPLICATIONS:

Dual Hermetically sealed surface mount version of the popular 2N3700 for high reliability/ space applications requiring small size and low weight devices.

ABSOLUTE MAXIMUM RATINGS

(T_{case} = 25°C unless otherwise stated)

		2N3700
V _{CBO}	Collector – Base Voltage	140V
V _{CEO}	Collector – Emitter Voltage (I _B = 0)	80V
V _{EBO}	Emitter – Base Voltage (I _B = 0)	7V
I _C	Collector Current	1A
P _D	Per Device Dissipation	350mW
P _D	Total Device Dissipation	525mW
P _D	Derate above 25°C (Per Device)	2mW / °C
	(Total)	3mW/°C
R _{ja}	Thermal Resistance Junction to Ambient	240°C/W
T _{stg}	Storage Temperature	-65 to 200°C

ELECTRICAL CHARACTERISTICS (per Device) ($T_{\text{case}} = 25^{\circ}\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{\text{CEO(sus)}}^*$ Collector – Emitter Sustaining Voltage ($I_{\text{B}} = 0$)	$I_{\text{C}} = 10\text{mA}$	80			V
I_{CBO}^* Collector – Base Cut-off Current ($I_{\text{E}} = 0$)	$V_{\text{CB}} = 90\text{V}$			10	nA
	$V_{\text{CB}} = 90\text{V}$ $T_{\text{amb}} = 150^{\circ}\text{C}$			10	μA
I_{EBO}^* Emitter Cut-off Current ($I_{\text{C}} = 0$)	$V_{\text{EB}} = 5\text{V}$			10	nA
$V_{\text{CE(sat)}}^*$ Collector – Emitter Saturation Voltage	$I_{\text{C}} = 150\text{mA}$ $I_{\text{B}} = 15\text{mA}$			0.2	V
	$I_{\text{C}} = 500\text{mA}$ $I_{\text{B}} = 50\text{mA}$			0.5	V
$V_{\text{BE(sat)}}^*$ Base – Emitter Saturation Voltage	$I_{\text{C}} = 150\text{mA}$ $I_{\text{B}} = 15\text{mA}$			1.1	V
h_{FE}^* DC Current Gain ($V_{\text{CE}} = 10\text{V}$)	$I_{\text{C}} = 0.1\text{mA}$ $V_{\text{CE}} = 10\text{V}$	50			-
	$I_{\text{C}} = 10\text{mA}$ $V_{\text{CE}} = 10\text{V}$	90			-
	$I_{\text{C}} = 150\text{mA}$ $V_{\text{CE}} = 10\text{V}$	100		300	-
	$I_{\text{C}} = 500\text{mA}$ $V_{\text{CE}} = 10\text{V}$	50			-
	$I_{\text{C}} = 1\text{A}$ $V_{\text{CE}} = 10\text{V}$	15			-
	$I_{\text{C}} = 150\text{mA}$ $V_{\text{CE}} = 10\text{V}$				-
$V_{\text{(BR)CBO}}$ Collector-base Breakdown Voltage ($I_{\text{E}} = 0$)	$I_{\text{C}} = 100\mu\text{A}$	140			V
$V_{\text{(BR)EBO}}$ Emitter-base Breakdown Voltage ($I_{\text{C}} = 0$)	$I_{\text{E}} = 100\mu\text{A}$	7			V

* Pulse test $t_{\text{p}} = 300\mu\text{s}$, $\delta \leq 1\%$

DYNAMIC CHARACTERISTICS ($T_{\text{case}} = 25^{\circ}\text{C}$ unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
f_{T} Transition Frequency	$I_{\text{C}} = 50\text{mA}$ $V_{\text{CE}} = 10\text{V}$ $f = 20\text{MHz}$	100		200	MHz
h_{fe} Small Signal Current Gain	$I_{\text{C}} = 1\text{mA}$ $V_{\text{CE}} = 5\text{V}$ $f = 1\text{kHz}$	80		400	-
C_{EBO} Emitter-base Capacitance	$I_{\text{C}} = 0$ $V_{\text{EB}} = 0.5\text{V}$ $f = 1\text{MHz}$			60	pF
C_{CBO} Collector-base Capacitance	$I_{\text{C}} = 0$ $V_{\text{CB}} = 10\text{V}$ $f = 1\text{MHz}$			12	pF
r_{bb} ${}^{\prime}C_{\text{b}^{\prime}\text{c}}$ Feedback time constant	$I_{\text{C}} = 10\text{mA}$ $V_{\text{CB}} = 10\text{V}$ $f = 4\text{MHz}$	25		400	ps